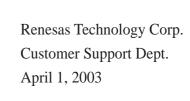
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2SB1399

Silicon PNP Triple Diffused

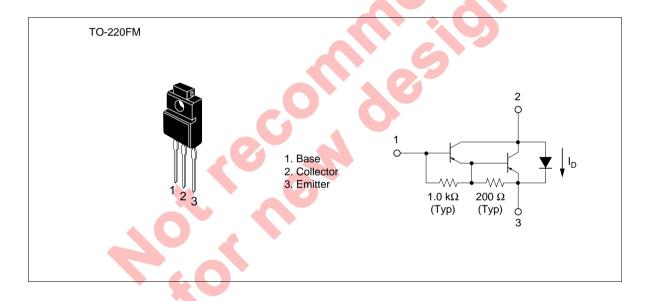


ADE-208-873 (Z) 1st. Edition September 2000

Application

Low frequency power amplifier

Outline



2SB1399

Absolute Maximum Ratings ($Ta = 25^{\circ}C$)

Item	Symbol	Ratings	Unit V	
Collector to base voltage	V_{CBO}	-120		
Collector to emitter voltage	V _{CEO}	-120	V	
Emitter to base voltage	V _{EBO} –7		V	
Collector current	I _c	-10	А	
Collector peak current	I _{C (peak)}	– 15	А	
Collector power dissipation	P _c	2	W	
	P _c * ¹	30		
Junction temperature	Tj	150	°C	
Storage temperature	Tstg	-55 to +150	°C	
C to E diode forward current	I _D *1	10	Α	

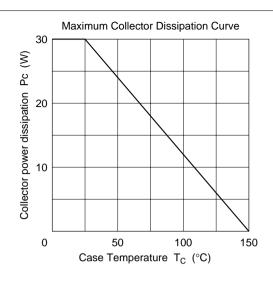
Note: 1. Value at $T_c = 25$ °C.

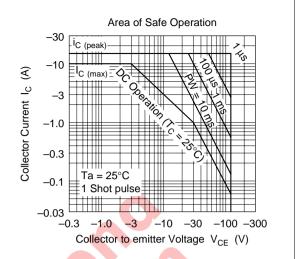
Electrical Characteristics ($Ta = 25^{\circ}C$)

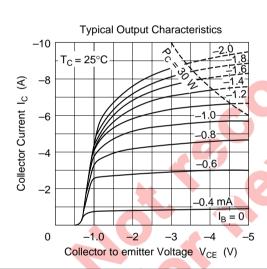
Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Collector to base breakdown voltage	$V_{(BR)CBO}$	-120	-	Ò	V	$I_{\rm C} = -0.1 \text{ mA}, I_{\rm E} = 0$
Collector to emitter breakdown voltage	$V_{(BR)CEO}$	-120	1	_	V	$I_{\rm C}$ = -25 mA, $R_{\rm BE}$ = ∞
Emitter to base breakdown voltage	$V_{(BR)EBO}$	-7		_	V	$I_{\rm E} = -50 \text{ mA}, I_{\rm C} = 0$
Collector cutoff current	СВО		_	-10	μΑ	$V_{CB} = -100 \text{ V}, I_{E} = 0$
	I _{CEO}	-	_	-10	_	V _{CE} = −100 V, R _{BE} = ∞
DC current transfer ratio	h _{FE}	1000	_	20000		$V_{CE} = -3 \text{ V}, I_{C} = -5 \text{ A}^{*1}$
Collector to emitter saturation	V _{CE (sat)1}	_	_	-1.5	V	$I_{\rm C} = -5 \text{ A}, I_{\rm B} = 10 \text{ mA}^{*1}$
voltage	V _{CE (sat)2}	_	_	-3.0	_	$I_{\rm C} = -10 \text{ A}, I_{\rm B} = -100 \text{ mA}^{*1}$
Base to emitter saturation	V _{BE (sat)1}	_	_	-2.0	V	$I_{\rm C} = -5 \text{ A}, I_{\rm B} = 10 \text{ mA}^{*1}$
voltage	V _{BE (sat)2}	_	_	-3.5	_	$I_{\rm C} = -10 \text{ A}, I_{\rm B} = -100 \text{ mA}^{*1}$
C to E diode forward voltage	V _D	_	_	3.0	V	I _D = 10 A* ¹

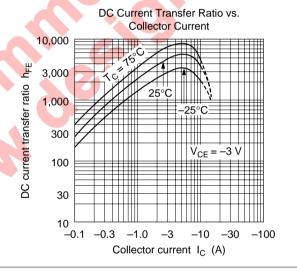
Note: 1. Pulse Test.

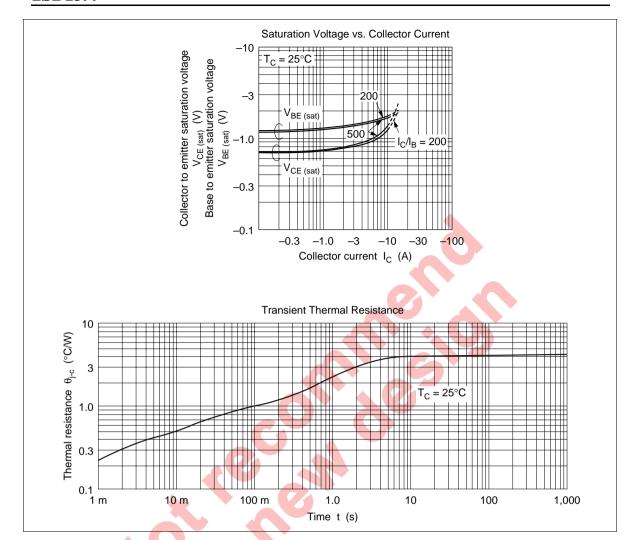
See switching characteristic curve of 2SB955(K).











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